

Diode

Silicon Carbide Schottky Diode

IDH20G120C5

5th Generation CoolSiC™ 1200 V SiC Schottky Diode

IDH20G120C5

Rev. 2.1 2017-07-21

Industrial Power Control



CoolSiCTM SiC Schottky Diode

Features:

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Qualified according to JEDEC¹⁾ for target applications
- Pb-free lead plating; RoHS compliant

Benefits

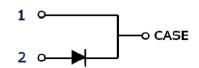
- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size / cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- RelatedLinks: www.infineon.com/sic

Applications

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- Power Factor Correction

Package pin definitions

- Pin 1 and backside cathode
- Pin 2 anode













Key Performance and Package Parameters

Туре	V_{DC}	I _F	Q _C	$T_{j,max}$	Marking	Package
IDH20G120C5	1200V	20A	82nC	175°C	D2012C5	PG-TO220-2-1

1) J-STD20 and JESD22





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Table of Contents

Description	2
Table of Contents	
Maximum Ratings	
Thermal Resistances	
Electrical Characteristics	
Electrical Characteristics Diagram	
Package Drawings	
Revision History	
Disclaimer	



Maximum ratings

Parameter	Symbol	Value	Unit	
Repetitive peak reverse voltage	V_{RRM}	1200	V	
Continues forward current for $R_{th(j-c,max)}$ $T_C = 150^{\circ}C$, D=1 $T_C = 135^{\circ}C$, D=1 $T_C = 25^{\circ}C$, D=1	I _F	20 27 56	А	
Surge non-repetitive forward current, sine halfwave $T_{\rm C}$ =25°C, $t_{\rm p}$ =10ms $T_{\rm C}$ =150°C, $t_{\rm p}$ =10ms	I F,SM	198 168	Α	
Non-repetitive peak forward current $T_C = 25^{\circ}C$, $t_D=10 \mu s$	<i>I</i> _{F,max} 1200		Α	
$i^{2}t$ value $T_{C} = 25^{\circ}C$, $t_{p}=10 \text{ ms}$ $T_{C} = 150^{\circ}C$, $t_{p}=10 \text{ ms}$	∫ i²dt	195 140	A²s	
Diode dv/dt ruggedness V _R =0960V	d <i>v</i> /d <i>t</i>	80	V/ns	
Power dissipation $T_C = 25$ °C	P _{tot}	330	W	
Operating and storage temperature	$T_{\rm j}$; $T_{ m stg}$	-55175	°C	
Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s	T _{sold}	260	°C	
Mounting torque M3 and M4 screws	М	0.7	Nm	

Thermal Resistances

Parameter	Cumbal	Conditions min.		Value	Unit	
raiailletei	Symbol		min.	typ.	max.	Oilit
Characteristic						
Diode thermal resistance, junction – case	R _{th(j-c)}		-	0.35	0.46	K/W
Thermal resistance, junction – ambient	R _{th(j-a)}	leaded	-	-	62	K/W



Electrical Characteristics

Static Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions		Value	Unit	
raiailletei		Conditions	min.	typ.	max.	Oilit
Static Characteristic						
DC blocking voltage	$V_{ m DC}$	<i>T</i> _j = 25°C	1200	-	-	V
Diode forward voltage	1/	<i>I</i> _F = 20A, <i>T</i> _j =25°C	-	1.5	1.8	V
Diode forward voltage	V_{F}	$I_{\rm F}$ = 20A, $T_{\rm j}$ =150°C	-	2.0	2.6	
Reverse current	,	V _R =1200V, T _j =25°C		8.5	123	μA
Reverse current	I _R	V _R =1200V, T _j =150°C		44	630	

Dynamic Characteristics, at T_j=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
rai ailletei	Syllibol		min.	typ.	max.	Oilit
Dynamic Characteristics	Dynamic Characteristics					
Total capacitive charge		V _R =800V, T _j =150°C				
	Q_{C}	$Q_C = \int_C^{V_R} C(V) dV$	-	82	-	nC
		0				
		V _R =1 V, <i>f</i> =1 MHz	-	1050	-	
Total Capacitance	С	V _R =400 V, <i>f</i> =1 MHz	-	74	-	pF
		V _R =800 V, f=1 MHz	-	59	-	



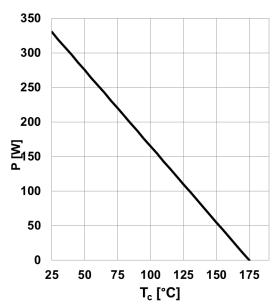


Figure 1. Power dissipation as a function of case temperature, $P_{\text{tot}} = f(T_{\text{C}}, R_{\text{th(j-c),max}})$

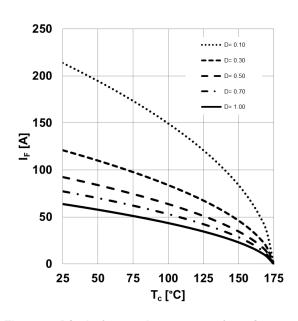


Figure 2. Diode forward current as function of temperature, $T_j \le 175$ °C, $R_{\text{th(j-c)},\text{max}}$, parameter D=duty cycle, V_{th} , R_{diff} @ $T_j = 175$ °C

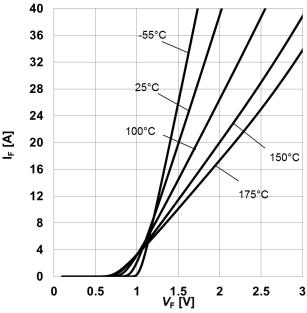


Figure 3. **Typical forward characteristics,** $I_F = f(V_F)$, $t_D = 10 \mu s$, parameter: T_i

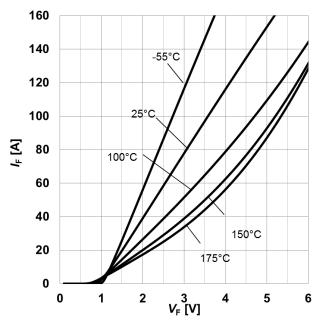


Figure 4. Typical forward characteristics in surge current, $I_F=f(V_F)$, $t_p=10 \mu s$, parameter: T_i



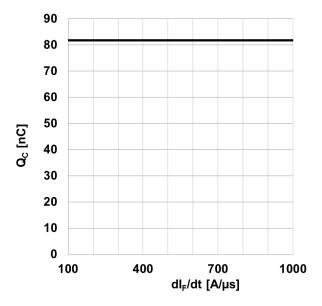


Figure 5. **Typical capacitive charge as function** of current slope¹, $Q_C=f(dI_F/dt)$, $T_j=150^{\circ}C$ 1) Only capacitive charge, guaranteed by design.

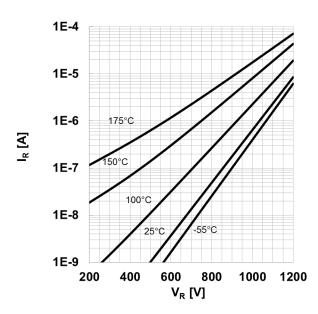


Figure 6. Typical reverse current as function of reverse voltage, $I_R = f(V_R)$, parameter: T_i

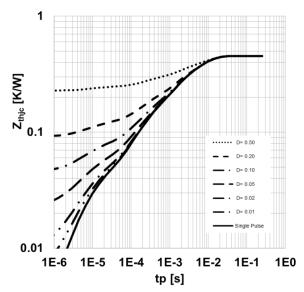


Figure 7. **Max. transient thermal impedance,** $Z_{\text{th,jc}} = f(t_P)$, parameter: $D = t_P/T$

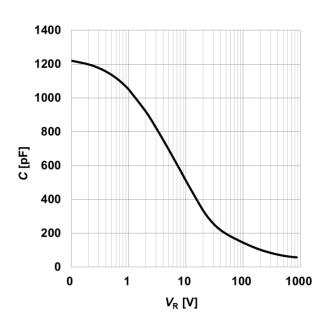


Figure 8. Typical capacitance as function of reverse voltage, $C=f(V_R)$; $T_j=25$ °C; f=1 MHz

Final Data Sheet 7 Rev. 2.1, 2017-07-21



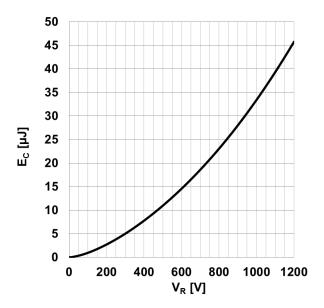
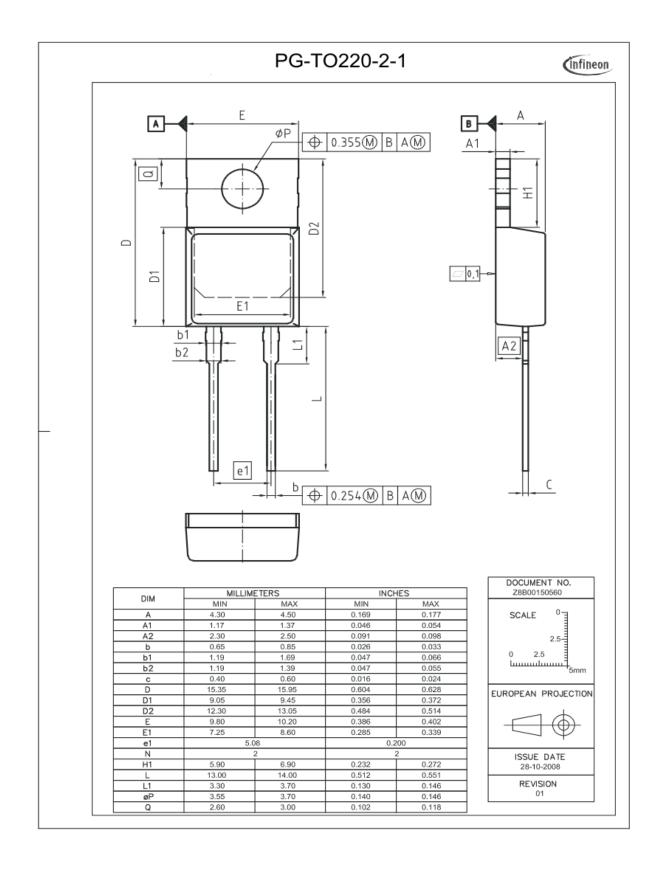


Figure 9. **Typical capacitively stored energy as** function of reverse voltage,

$$E_C = \int_0^{V_R} C(V)VdV$$









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Revision History

IDH20G120C5

Revision: 2017-07-21, Rev. 2.1

Previous Revision:

FTEVIOUS REVISION.					
Revision	Date Subjects (major changes since last version)				
2.0	2015-09-03	Final data sheet			
2.1	-	Editorial Changes			

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Final Data Sheet 11 Rev. 2.1, 2017-07-21